

3.81mmx19.05mm LED LIGHT BAR

Part Number: KB-F100SURKW

Hyper Red

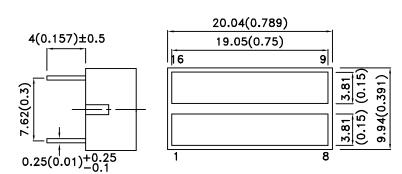
Features

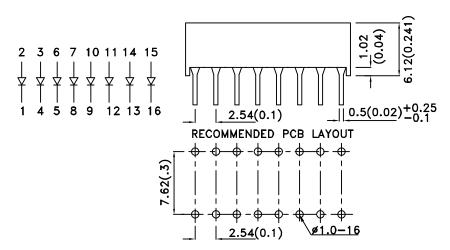
- Uniform light emitting area.
- Low current operation.
- Easily mounted on P.C. boards.
- Flush mountable.
- Excellent on/off contrast.
- Can be used with panels and legend mounts.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

Package Dimensions& Internal Circuit Diagram









PAGE: 1 OF 6

ERP: 1334000678

Notes

- 1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
- 2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SPEC NO: DSAM8387 REV NO: V.1A DATE: JAN/23/2013
APPROVED: WYNEC CHECKED: Joe Lee DRAWN: F.Cui

Selection Guide

| Part No. | Dice | Lens Type | lv (mcd) [1] @ 20mA | |
|---------------|--|---|------------------------|------|
| | | ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,, | Min. | Тур. |
| KB E100SLIBKW | 00SURKW Hyper Red (AlGaInP) White Diffused | White Diffused | 120 | 230 |
| ND-1 10030KKW | | Willie Diliused | *20 | *60 |

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|-----------|------|------|-------|---------------------------|
| λpeak | Peak Wavelength | Hyper Red | 645 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Hyper Red | 630 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Hyper Red | 28 | | nm | IF=20mA |
| С | Capacitance | Hyper Red | 35 | | pF | V _F =0V;f=1MHz |
| VF [2] | Forward Voltage | Hyper Red | 1.95 | 2.5 | V | IF=20mA |
| lR | Reverse Current | Hyper Red | | 10 | uA | V _R =5V |

- 1.Wavelength: +/-1nm.
 2. Forward Voltage: +/-0.1V.
 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

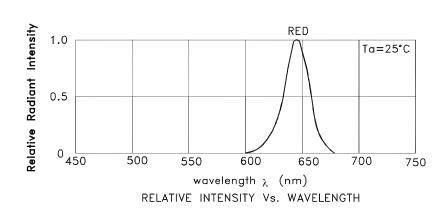
Absolute Maximum Ratings at TA=25°C

| Parameter | Hyper Red | Units |
|--|--|-------|
| Power dissipation | 75 | mW |
| DC Forward Current | 30 | mA |
| Peak Forward Current [1] | 185 | mA |
| Reverse Voltage | 5 | V |
| Operating / Storage Temperature | erating / Storage Temperature -40°C To +85°C | |
| _ead Solder Temperature[2] 260°C For 3-5 Seconds | | |

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
 2. 2mm below package base.

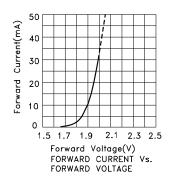
SPEC NO: DSAM8387 **REV NO: V.1A** DATE: JAN/23/2013 PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED:** Joe Lee DRAWN: F.Cui ERP: 1334000678

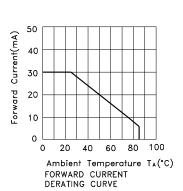
^{1.} Luminous intensity/ luminous Flux: +/-15%.
*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

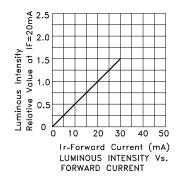


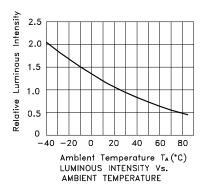
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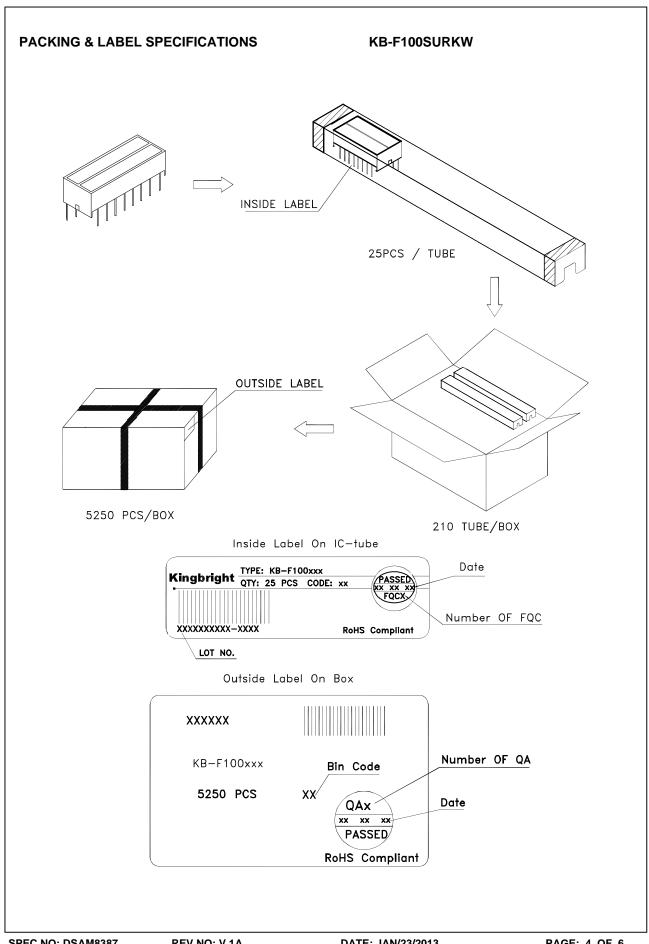
KB-F100SURKW











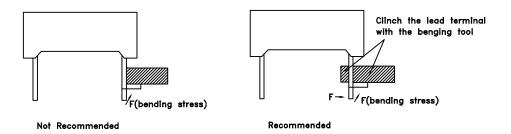
SPEC NO: DSAM8387 APPROVED: WYNEC REV NO: V.1A CHECKED: Joe Lee DATE: JAN/23/2013 DRAWN: F.Cui

PAGE: 4 OF 6 ERP: 1334000678

THROUGH HOLE DISPLAY MOUNTING METHOD

Lead Forming

Do not bend the component leads by hand without proper tools. The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

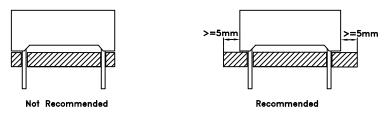


Installation

- 1. The installation process should not apply stress to the lead terminals.
- 2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.



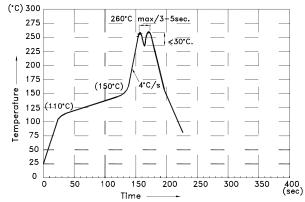
3. The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



SPEC NO: DSAM8387 APPROVED: WYNEC REV NO: V.1A CHECKED: Joe Lee DATE: JAN/23/2013 DRAWN: F.Cui PAGE: 5 OF 6 ERP: 1334000678

DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering , the PCB top—surface temperature should be kept below 105°C 5.No more than once.

Soldering General Notes:

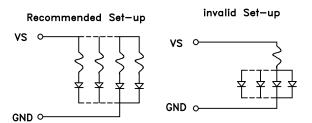
- 1. Through—hole displays are incompatible with reflow soldering.
- 2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- 2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES

- 1.Protective current-limiting resistors may be necessary to operate the Displays.
- 2.LEDs mounted in parallel should each be placed in series with its own current—limiting resistor.



All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

 SPEC NO: DSAM8387
 REV NO: V.1A
 DATE: JAN/23/2013
 PAGE: 6 OF 6

 APPROVED: WYNEC
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